

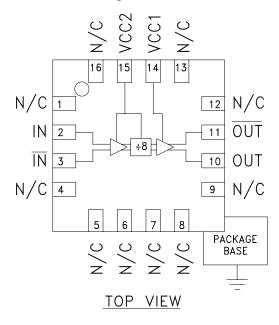


### **Typical Applications**

Prescaler for DC to 18 GHz PLL Applications:

- Point-to-Point / Multi-Point Radios
- VSAT Radios
- Fiber Optic
- Test Equipment
- Military

#### **Functional Diagram**



# HMC494LP3 / 494LP3E

## SMT GaAs HBT MMIC DIVIDE-BY-8, DC - 18 GHz

#### Features

Ultra Low SSB Phase Noise: -150 dBc/Hz Very Wide Bandwidth Output Power: -4 dBm Single DC Supply: +5V 16 Lead 3x3mm QFN Package: 9 mm<sup>2</sup>

#### **General Description**

The HMC494LP3 & HMC494LP3E are low noise Divide-by-8 Static Dividers utilizing InGaP GaAs HBT technology packaged in leadless 3x3 mm QFN surface mount plastic packages. This device operates from DC (with a square wave input) to 18 GHz input frequency from a single +5V DC supply. The low additive SSB phase noise of -150 dBc/Hz at 100 kHz offset helps the user maintain excellent system noise performance.

### Electrical Specifications, $T_A = +25^{\circ}$ C, 50 Ohm System, Vcc= +5V

Parameter	Conditions	Min.	Тур.	Max.	Units
Maximum Input Frequency		18	19		GHz
Minimum Input Frequency	Sine Wave Input. [1]		0.2	0.5	GHz
Input Power Range	Fin = 2 to 12 GHz	-20	-15	+10	dBm
	Fin = 12 to 16 GHz	-20	-15	+3	dBm
	Fin = 16 to 18 GHz	-15	-10	0	dBm
Output Power	Fin = 0.5 to 18 GHz	-7	-4		dBm
Reverse Leakage	Both RF Outputs Terminated		55		dB
SSB Phase Noise (100 kHz offset)	Pin = 0 dBm, Fin = 6 GHz		-150		dBc/Hz
Output Transition Time	Pin = 0 dBm, Fout = 882 MHz		100	İ	ps
Supply Current (Icc1 + Icc2)			103		mA

#### 1. Divider will operate down to DC for square-wave input signal

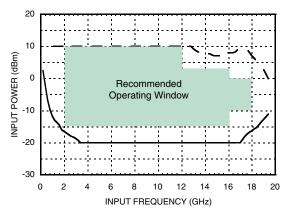
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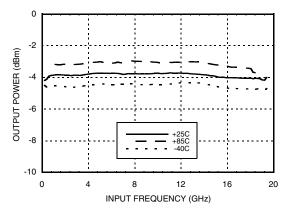


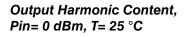


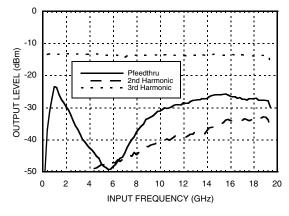
#### Input Sensitivity Window, T= 25 °C



**Output Power vs. Temperature** 



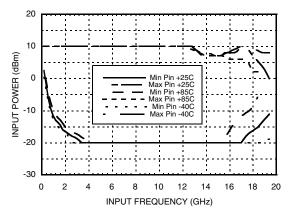




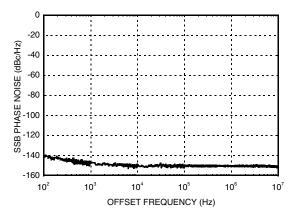
# HMC494LP3 / 494LP3E

## SMT GaAs HBT MMIC DIVIDE-BY-8, DC - 18 GHz

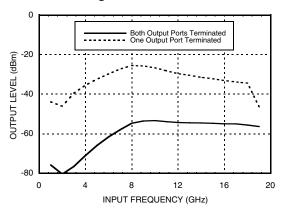
#### Input Sensitivity Window vs. Temperature



SSB Phase Noise Performance, Pin= 0 dBm, T= 25 °C



Reverse Leakage, Pin= 0 dBm, T= 25 °C

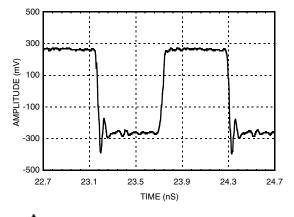


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**Output Voltage Waveform,** Pin= 0 dBm, Fout= 882 MHz, T= 25 °C





#### ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

# HMC494LP3 / 494LP3E

# SMT GaAs HBT MMIC DIVIDE-BY-8, DC - 18 GHz

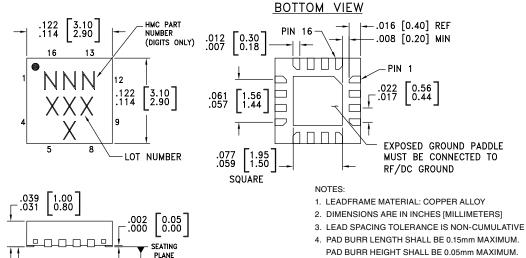
#### Absolute Maximum Ratings

RF Input (Vcc = +5V)	+13 dBm
Supply Voltage (Vcc1, Vcc2)	+5.5V
Channel Temperature (Tc)	135 °C
Continuous Pdiss (T = 85 °C) (derate 11.9 mW/° C above 85 °C)	593 mW
Thermal Resistance (R <sub>TH</sub> ) (junction to ground paddle)	84 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

### Typical Supply Current vs. Vcc

Vcc1, Vcc2 (V)	lcc (mA)
4.75	90
5.0	103
5.25	115

Note: Divider will operate over full voltage range shown above



#### PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.

- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN

## Package Information

.003[0.08] C

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC494LP3	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 <sup>[1]</sup>	494 XXXX
HMC494LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	<u>494</u> XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

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# **Outline Drawing**



HMC494LP3 / 494LP3E

## SMT GaAs HBT MMIC DIVIDE-BY-8, DC - 18 GHz



### **Pin Description**

Pin Number	Function	Description	Interface Schematic
1, 4-9, 12, 13, 16	N/C	No connection.	
2	IN	RF Input must be DC blocked.	500 IN 0
3	ĪN	RF Input 180° out of phase with pin 2 for differential operation. AC ground for single ended operation.	500 NO
10	OUT	Divided Output.	Vcc 0 5V
11	OUT	Divided output 180° out of phase with pin 10.	Vcc 05V
14, 15	Vcc1, Vcc2	Supply voltage 5V $\pm$ 0.25V. Connect both pins to +5V supply.	
	GND	Ground: Backside of package has exposed metal ground slug which must be connected to RF/DC ground.	

FREQUENCY DIVIDERS & DETECTORS - SMT

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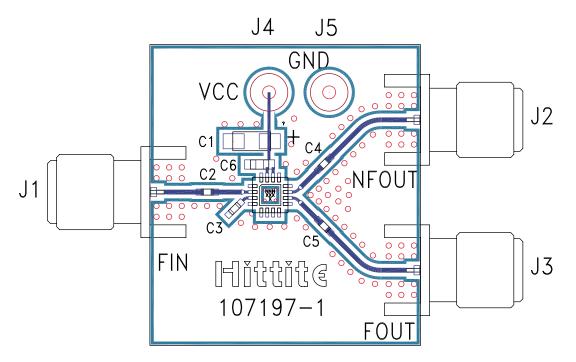
# HMC494LP3 / 494LP3E

#### v05.1211



## SMT GaAs HBT MMIC DIVIDE-BY-8, DC - 18 GHz

### Evaluation PCB



### List of Materials for Evaluation PCB 107384 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
J4, J5	DC Pin
C2 - C5	100 pF Capacitor, 0402 Pkg.
C6	1000 pF Capacitor, 0603 Pkg.
C1	2.2 uF Tantalum Capacitor
U1	HMC494LP3 / HMC494LP3E Divide-by-2
PCB [2]	107197 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and backside ground slug should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. This evaluation board is designed for single ended input testing. J2 and J3 provide differential output signals.

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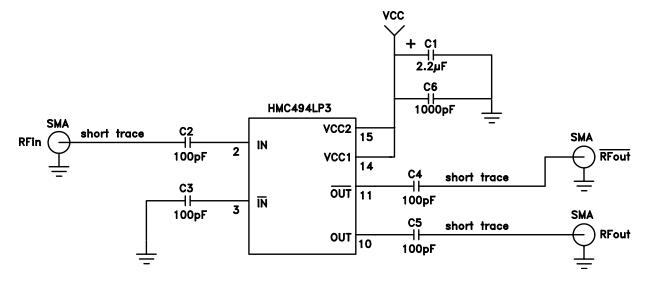


# HMC494LP3 / 494LP3E

## SMT GaAs HBT MMIC DIVIDE-BY-8, DC - 18 GHz



**Application Circuit** 



v05.1211

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